

## VOLTAGE DETECTORS

### FEATURES

- Qualified for Automotive Applications
- Single Voltage Detector (TPS3803):  
Adjustable/1.5 V
- Dual Voltage Detector (TPS3805):  
Adjustable/3.3 V
- High  $\pm 1.5\%$  Threshold Voltage Accuracy
- Supply Current: 3  $\mu\text{A}$  Typical at  $V_{DD} = 3.3 \text{ V}$
- Push/Pull Reset Output (TPS3805),  
Open-Drain Reset Output (TPS3803)
- Temperature Range:  $-40^\circ\text{C}$  to  $125^\circ\text{C}$
- 5-Pin SC-70 Package

### DESCRIPTION

The TPS3803 and TPS3805 families of supervisory circuits provide circuit initialization and timing supervision, primarily for DSPs and processor-based systems.

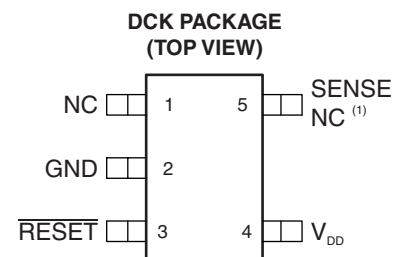
The TPS3803G15 device has a fixed-sense threshold voltage  $V_{IT}$  set by an internal voltage divider, whereas the TPS3803-01 has an adjustable SENSE input that can be configured by two external resistors. In addition to the fixed sense threshold monitored at  $V_{DD}$ , the TPS3805 devices provide a second adjustable SENSE input.  $\overline{\text{RESET}}$  is asserted in case either of the two voltages drops below  $V_{IT}$ .

During power on,  $\overline{\text{RESET}}$  is asserted when supply voltage  $V_{DD}$  becomes higher than 0.8 V. Thereafter, the supervisory circuit monitors  $V_{DD}$  (and/or SENSE) and keeps  $\overline{\text{RESET}}$  active as long as  $V_{DD}$  or SENSE remains below the threshold voltage  $V_{IT}$ . As soon as  $V_{DD}$  (SENSE) rises above the threshold voltage  $V_{IT}$ ,  $\overline{\text{RESET}}$  is deasserted again. The product spectrum is designed for 1.5 V, 3.3 V, and adjustable supply voltages.

The devices are available in a 5-pin SC-70 package. The TPS3803 and TPS3805 devices are characterized for operation over a temperature range of  $-40^\circ\text{C}$  to  $125^\circ\text{C}$ .

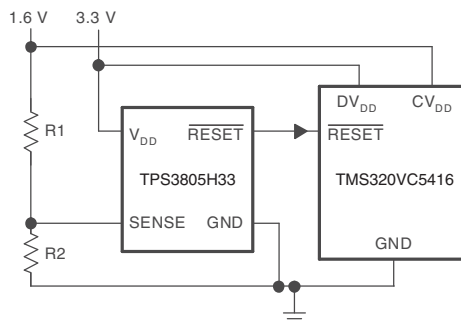
### APPLICATIONS

- Applications Using DSPs, Microcontrollers, or Microprocessors
- Wireless Communication Systems
- Portable/Battery-Powered Equipment
- Programmable Controls
- Intelligent Instruments
- Industrial Equipment
- Notebook/Desktop Computers
- Automotive Systems



NC – No connection

(1) SENSE on TPS3803-01, TPS3805H33  
NC on TPS3803G15



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

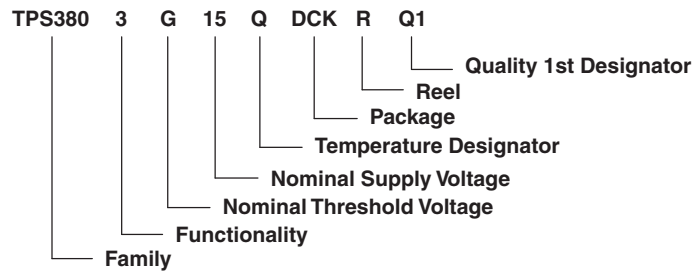
ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## ORDERING INFORMATION<sup>(1)</sup>

$T_A$	THRESHOLD VOLTAGE		PACKAGE <sup>(2)</sup>		ORDERABLE PART NUMBER	TOP-SIDE MARKING
	$V_{DD}$	SENSE				
–40°C to 125°C	NA	1.226 V	SC-70 – DCK	Reel of 3000	TPS3803-01QDCKRQ1	AWJ
	1.4 V	NA			TPS3803G15QDCKRQ1	AXU
	3.05 V	1.226 V			TPS3805H33QDCKRQ1	AWZ

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](http://www.ti.com).

(2) Package drawings, thermal data, and symbolization are available at [www.ti.com/packaging](http://www.ti.com/packaging).



## FUNCTION/TRUTH TABLE

TPS3803-01	
$SENSE > V_{IT}$	$\overline{RESET}$
0	L
1	H

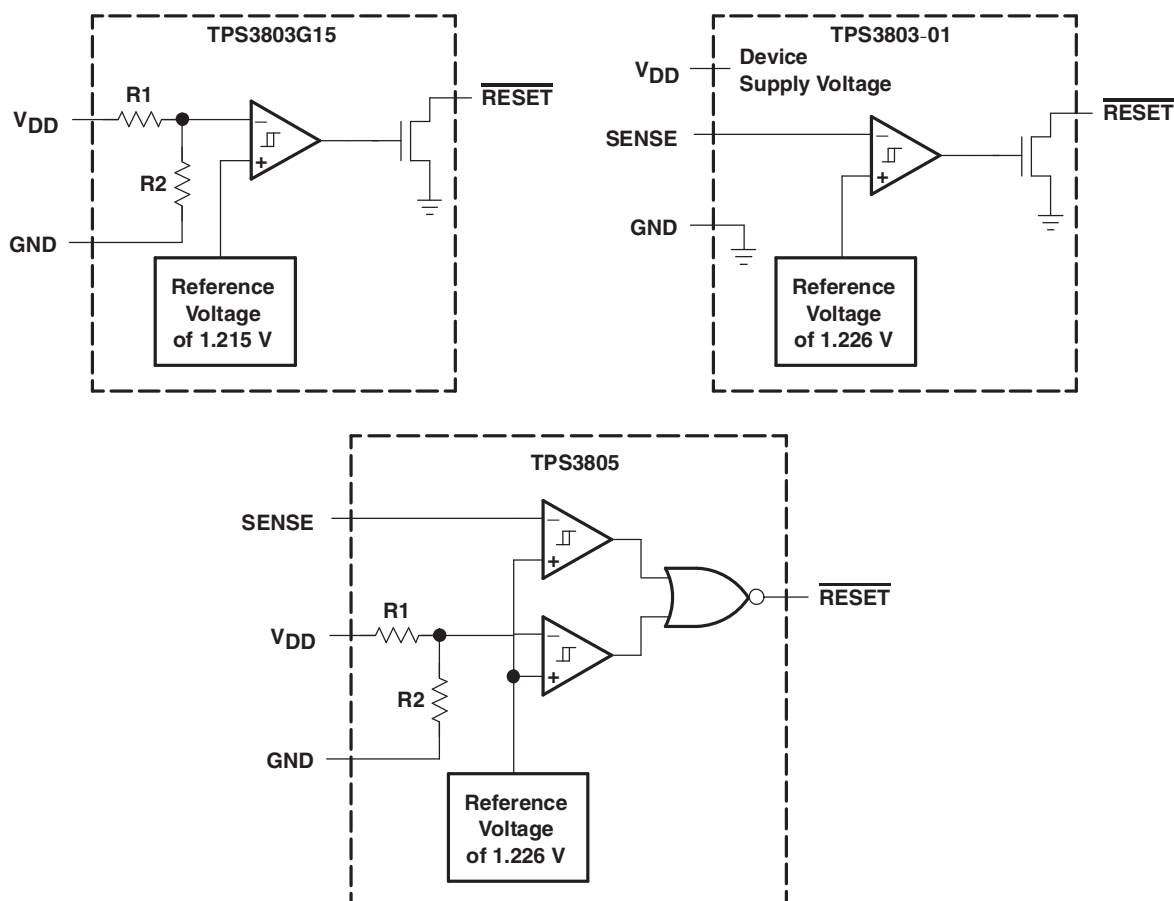
## FUNCTION/TRUTH TABLE

TPS3803G15	
$V_{DD} > V_{IT}$	$\overline{RESET}$
0	L
1	H

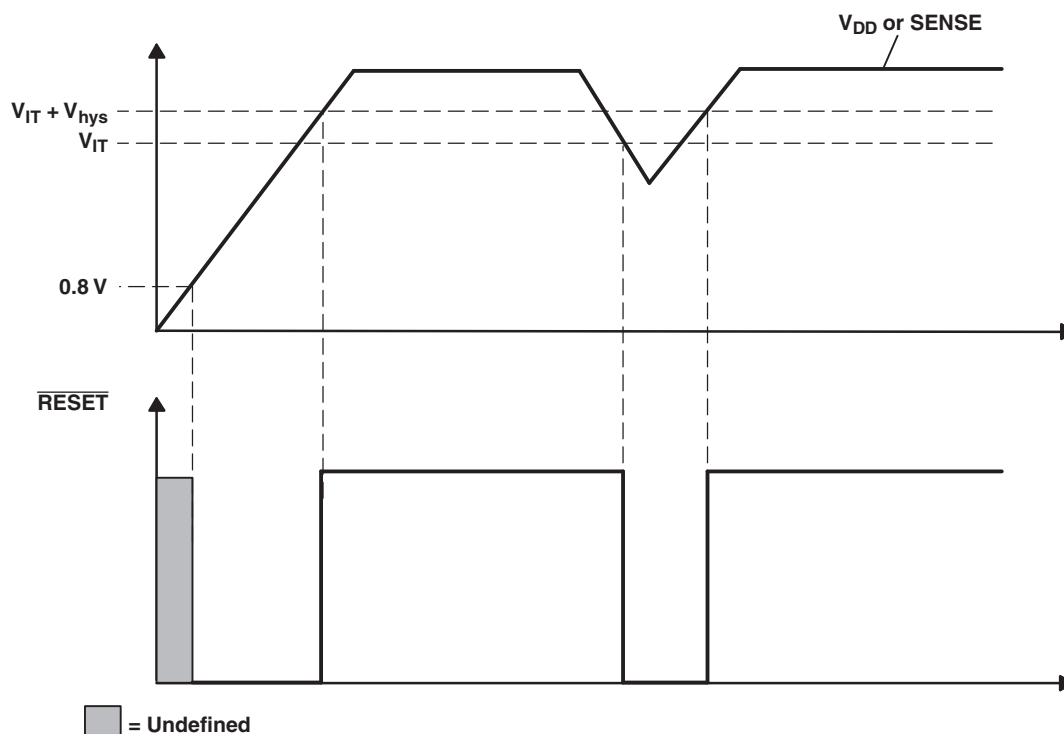
## FUNCTION/TRUTH TABLE

TPS3805H33		
$V_{DD} > V_{IT}$	$SENSE > V_{IT}$	$\overline{RESET}$
0	0	L
0	1	L
1	0	L
1	1	H

## FUNCTIONAL BLOCK DIAGRAM



## TIMING REQUIREMENTS



## TERMINAL FUNCTIONS

TERMINAL		I/O	DESCRIPTION
NAME	NO.		
GND	2	I	Ground
RESET	3	O	Active-low reset output (TPS3803: open drain, TPS3805: push/pull)
SENSE	5	I	Adjustable sense input
NC	1		No internal connection
NC (TPS3803G15)	5		No internal connection
$V_{DD}$	4	I	Input supply voltage, fixed sense input for TPS3803G15 and TPS3805

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

			VALUE
$V_{DD}$	Supply voltage <sup>(2)</sup>		7 V
	Voltage applied to all other pins <sup>(2)</sup>		–0.3 V to 7 V
$I_{OL}$	Maximum low-level output current		5 mA
$I_{OH}$	Maximum high-level output current		–5 mA
$I_{IK}$	Input clamp current	$V_I < 0$ or $V_I > V_{DD}$	±10 mA
$I_{OK}$	Output clamp current	$V_O < 0$ or $V_O > V_{DD}$	±10 mA
$P_D$	Continuous total power dissipation		See Dissipation Rating Table
$T_A$	Operating free-air temperature range		–40°C to 125°C
$T_{stg}$	Storage temperature range		–65°C to 150°C
$T_{solder}$	Soldering temperature		260°C

- (1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to GND. For reliable operation, the device should not be continuously operated at 7 V for more than  $t = 1000$  h.

## DISSIPATION RATINGS

PACKAGE	POWER RATING $T_A < 25^\circ\text{C}$	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	POWER RATING $T_A = 70^\circ\text{C}$	POWER RATING $T_A = 85^\circ\text{C}$
DCK	321 mW	2.6 mW/°C	206 mW	167 mW

## RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
$V_{DD}$	Supply voltage	1.3	6	V
$V_I$	Input voltage	0	$V_{DD} + 0.3$	V
$T_A$	Operating free-air temperature	–40	125	°C

## ELECTRICAL CHARACTERISTICS

over operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS		MIN	TYP	MAX	UNIT	
V <sub>OH</sub>	High-level output voltage (TPS3805 only)		V <sub>DD</sub> = 1.5 V, I <sub>OH</sub> = −0.5 mA		0.8 × V <sub>DD</sub>			V	
			V <sub>DD</sub> = 3.3 V, I <sub>OH</sub> = −1 mA						
			V <sub>DD</sub> = 6 V, I <sub>OH</sub> = −1.5 mA						
V <sub>OL</sub>	Low-level output voltage		V <sub>DD</sub> = 1.5 V, I <sub>OL</sub> = 1 mA				0.3	V	
			V <sub>DD</sub> = 3.3 V, I <sub>OL</sub> = 2 mA						
			V <sub>DD</sub> = 6 V, I <sub>OL</sub> = 3 mA						
Power-up reset voltage <sup>(1)</sup>			V <sub>IT</sub> > 1.5 V, T <sub>A</sub> = 25°C		0.8			V	
			V <sub>IT</sub> ≤ 1.5 V, T <sub>A</sub> = 25°C		1				
V <sub>IT</sub>	Negative-going input threshold voltage <sup>(2)</sup>	SENSE			1.2	1.226	1.244	V	
		TPS3803G15			1.379	1.4	1.421		
		TPS3805H33			3.004	3.05	3.096		
V <sub>hys</sub>	Hysteresis		1.2 V < V <sub>IT</sub> < 2.5 V		15			mV	
			2.5 V < V <sub>IT</sub> < 3.5 V		30				
I <sub>I</sub>	Input current	SENSE			−25		25	nA	
I <sub>OH</sub>	High-level output current at RESET	Open drain only	V <sub>DD</sub> = V <sub>IT</sub> + 0.2 V, V <sub>OH</sub> = V <sub>DD</sub>				300	nA	
I <sub>DD</sub>	Supply current	TPS3803-01	V <sub>DD</sub> = 3.3 V, Output unconnected			2	4	μA	
		TPS3805, TPS3803G15				3	5		
		TPS3803-01	V <sub>DD</sub> = 6 V, Output unconnected			2	4		
		TPS3805, TPS3803G15				4	6		
C <sub>I</sub>	Input capacitance		V <sub>I</sub> = 0 V to V <sub>DD</sub>			1		pF	

(1) The lowest supply voltage at which RESET (V<sub>OL(max)</sub> = 0.2 V, I<sub>OL</sub> = 50 μA) becomes active. t<sub>r</sub>(V<sub>DD</sub>) ≥ 15 μs/V.

(2) To ensure the best stability of the threshold voltage, place a bypass capacitor (ceramic, 0.1 μF) near the supply terminals.

## TIMING REQUIREMENTS

R<sub>L</sub> = 1 MΩ, C<sub>L</sub> = 50 pF, T<sub>A</sub> = –40°C to 125°C (unless otherwise noted)

PARAMETER			TEST CONDITIONS		MIN	MAX	UNIT
t <sub>w</sub>	Pulse duration	V <sub>DD</sub>	V <sub>IH</sub> = 1.05 × V <sub>IT</sub> , V <sub>IL</sub> = 0.95 × V <sub>IT</sub>		5.5		μs
		SENSE					

## SWITCHING CHARACTERISTICS

R<sub>L</sub> = 1 MΩ, C<sub>L</sub> = 50 pF, T<sub>A</sub> = –40°C to 125°C (unless otherwise noted)

PARAMETER			TEST CONDITIONS		MIN	TYP	MAX	UNIT
t <sub>PHL</sub>	Propagation (delay) time, high-to-low-level output	V <sub>DD</sub> to RESET delay	V <sub>IH</sub> = 1.05 × V <sub>IT</sub> , V <sub>IL</sub> = 0.95 × V <sub>IT</sub>			5	100	μs
		SENSE to RESET delay						
t <sub>PLH</sub>	Propagation (delay) time, low-to-high-level output	V <sub>DD</sub> to RESET delay	V <sub>IH</sub> = 1.05 × V <sub>IT</sub> , V <sub>IL</sub> = 0.95 × V <sub>IT</sub>			5	100	μs
		SENSE to RESET delay						

## TYPICAL CHARACTERISTICS

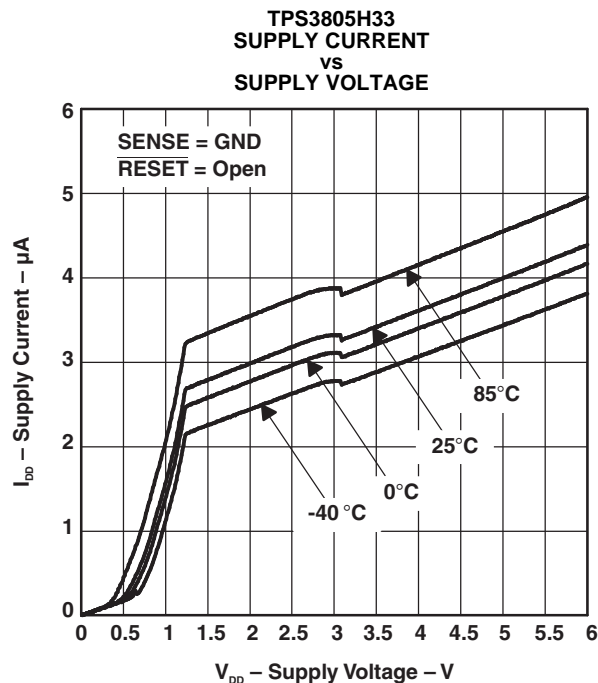


Figure 1.

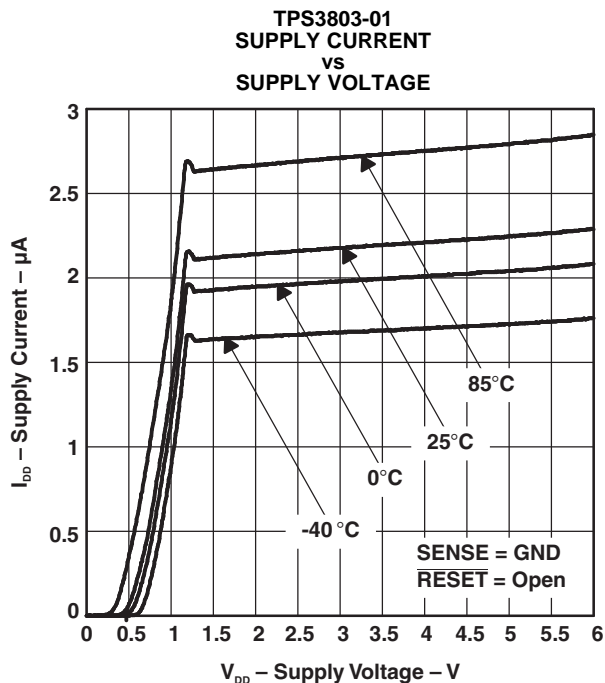


Figure 2.

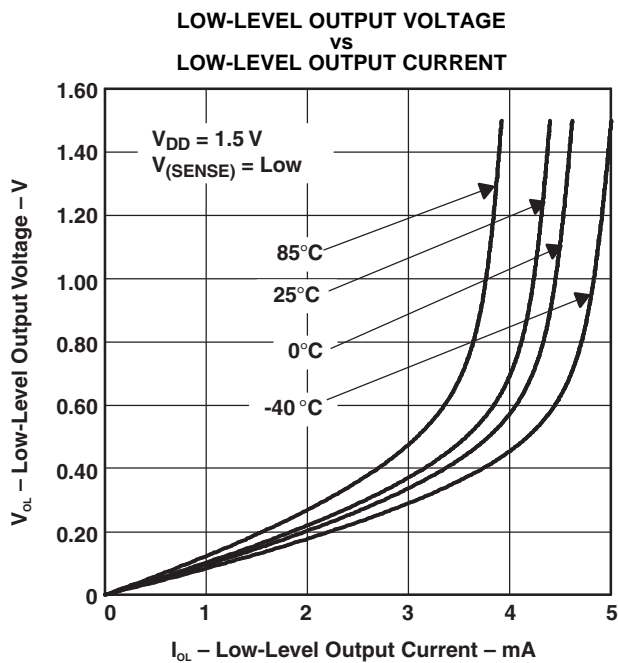


Figure 3.

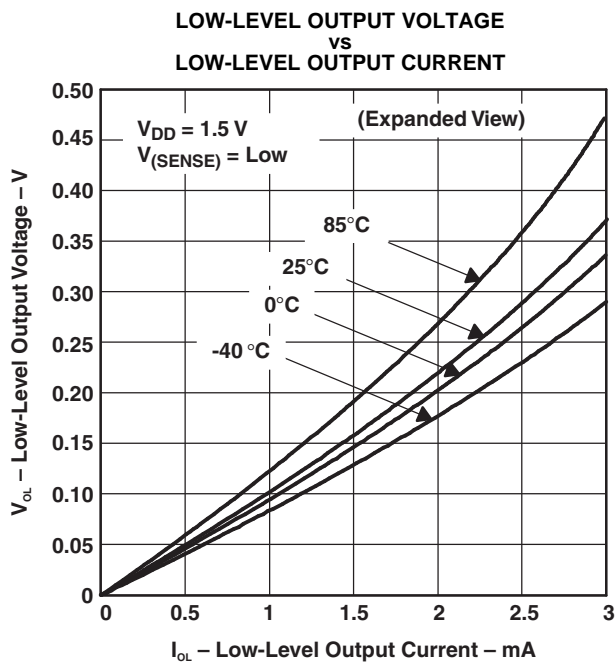


Figure 4.

# TYPICAL CHARACTERISTICS (continued)

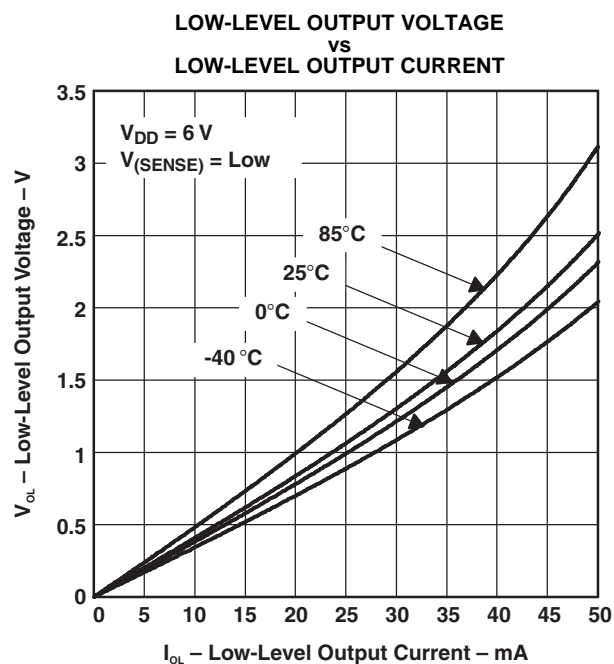


Figure 5.

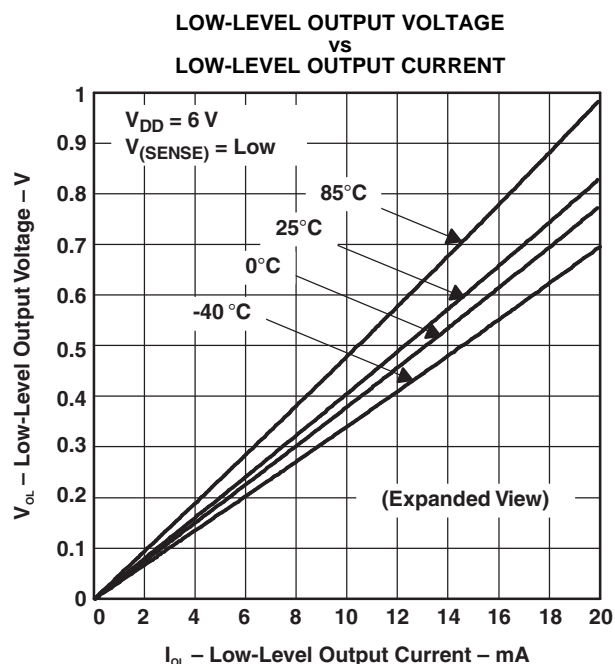


Figure 6.

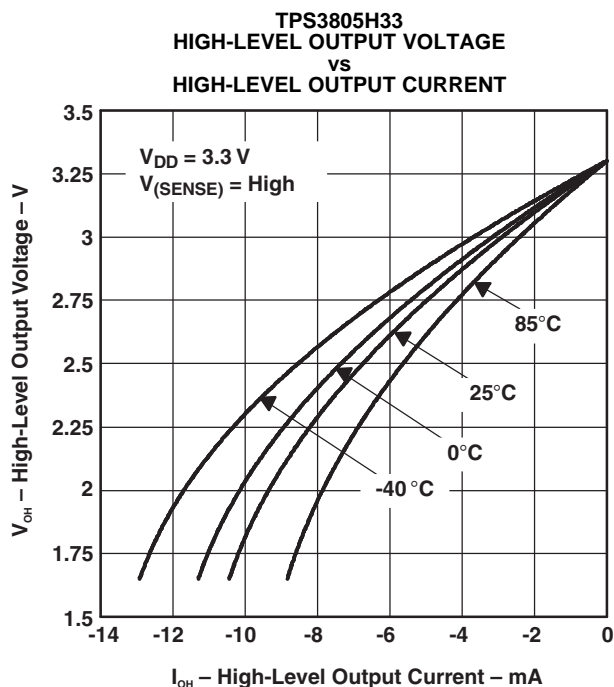


Figure 7.

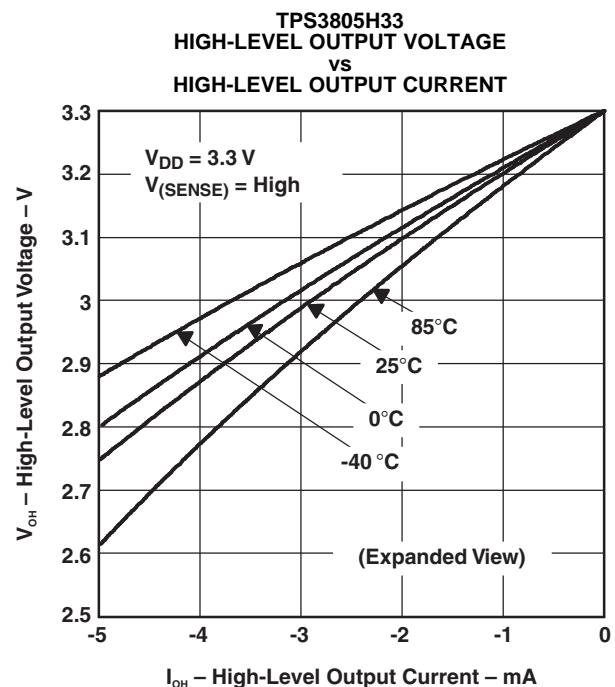


Figure 8.

## TYPICAL CHARACTERISTICS (continued)

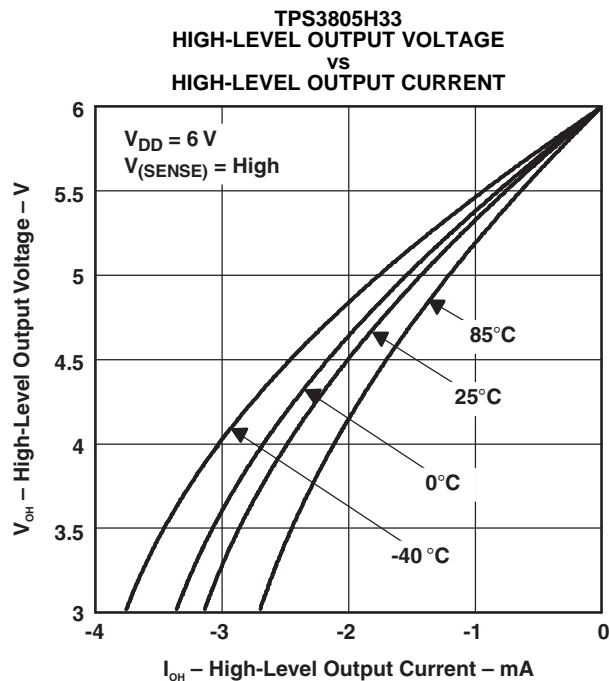


Figure 9.

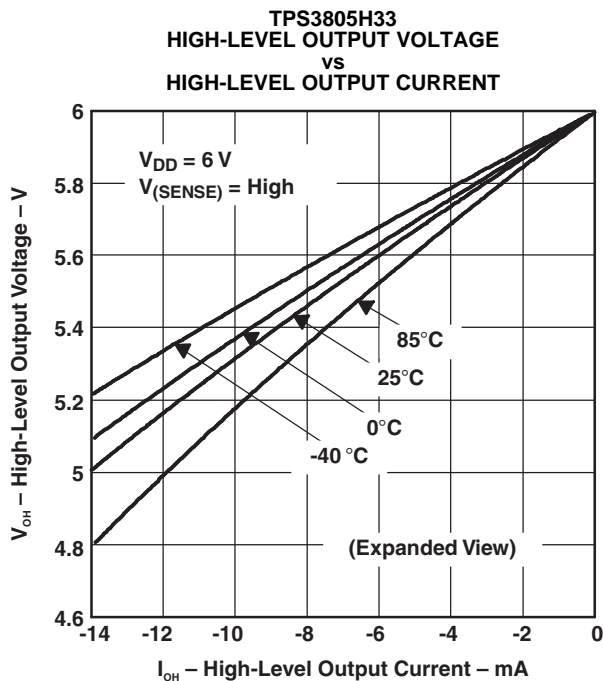


Figure 10.

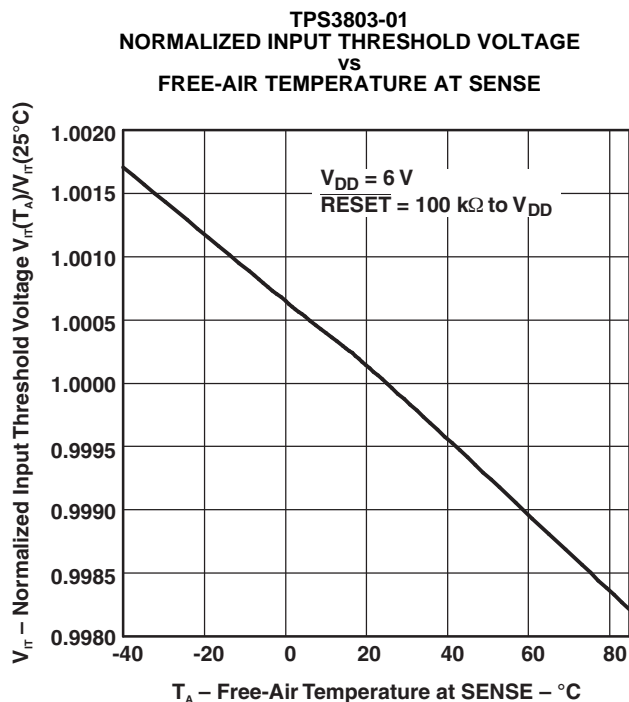


Figure 11.

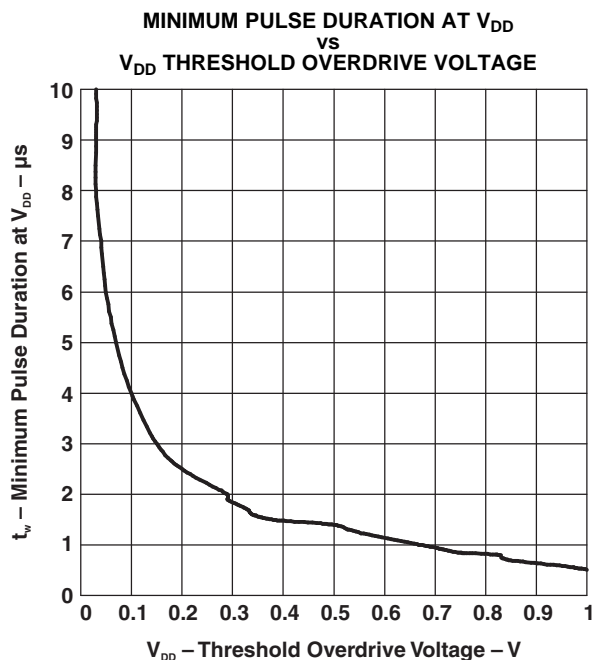


Figure 12.

## TYPICAL CHARACTERISTICS (continued)

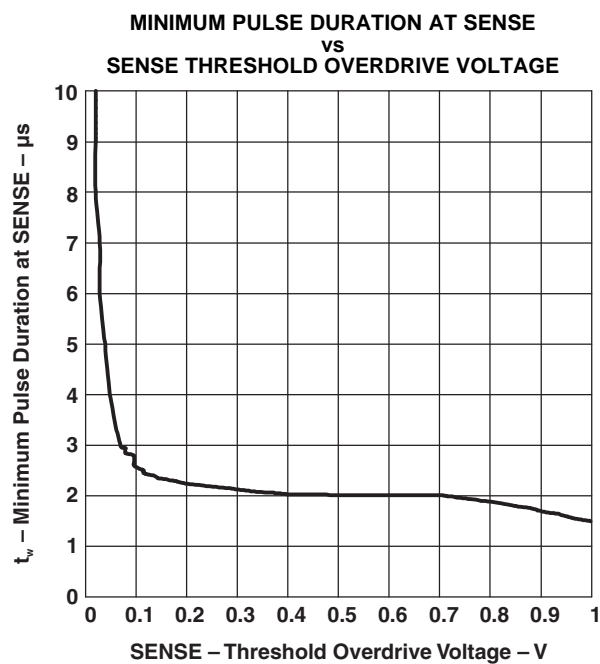


Figure 13.

### Revision History

REVISION	PAGE <sup>(1)</sup>	DESCRIPTION
SGLS228		Initial release
SGLS228A	1	Update features and description
	3	Update functional block diagram
SGLS228B	1	Update features

(1) Page numbers for previous revisions may differ from page numbers in the current version.

## PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
2T03-01QDCKRG4Q1	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AWJ	<a href="#">Samples</a>
2T03G15QDCKRG4Q	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AXU	<a href="#">Samples</a>
2T05H33QDCKRG4Q	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AWZ	<a href="#">Samples</a>
TPS3803-01QDCKRQ1	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AWJ	<a href="#">Samples</a>
TPS3803G15QDCKRQ1	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AXU	<a href="#">Samples</a>
TPS3805H33QDCKRQ1	ACTIVE	SC70	DCK	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	-40 to 125	AWZ	<a href="#">Samples</a>

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

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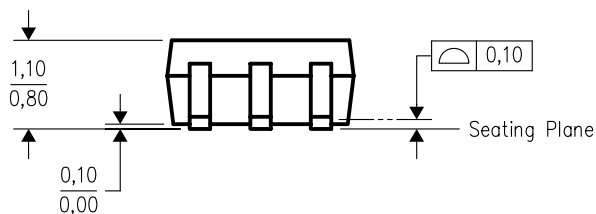
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF TPS3803-01-Q1, TPS3803G15-Q1, TPS3805H33-Q1 :**

- Catalog: [TPS3803-01](#), [TPS3803G15](#), [TPS3805H33](#)
- Enhanced Product: [TPS3803-01-EP](#), [TPS3803G15-EP](#), [TPS3805H33-EP](#)

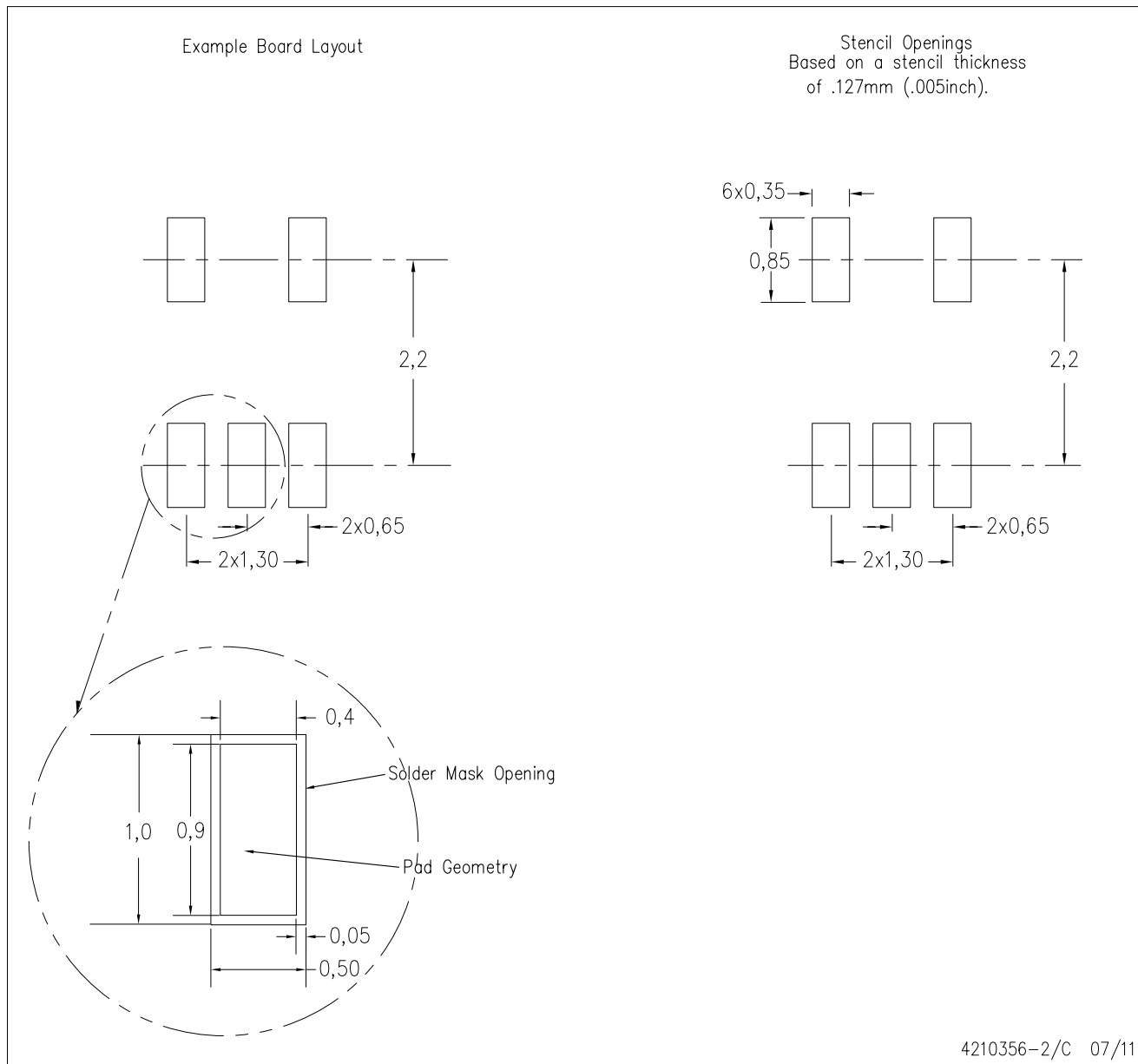
NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Enhanced Product - Supports Defense, Aerospace and Medical Applications



DCK (R-PDSO-G5)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
  - D. Publication IPC-7351 is recommended for alternate designs.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

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TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

### Products

Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>
DLP® Products	<a href="http://www.dlp.com">www.dlp.com</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>
Clocks and Timers	<a href="http://www.ti.com/clocks">www.ti.com/clocks</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>
RFID	<a href="http://www.ti-rfid.com">www.ti-rfid.com</a>
OMAP Applications Processors	<a href="http://www.ti.com/omap">www.ti.com/omap</a>
Wireless Connectivity	<a href="http://www.ti.com/wirelessconnectivity">www.ti.com/wirelessconnectivity</a>

### Applications

Automotive and Transportation	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
Communications and Telecom	<a href="http://www.ti.com/communications">www.ti.com/communications</a>
Computers and Peripherals	<a href="http://www.ti.com/computers">www.ti.com/computers</a>
Consumer Electronics	<a href="http://www.ti.com/consumer-apps">www.ti.com/consumer-apps</a>
Energy and Lighting	<a href="http://www.ti.com/energy">www.ti.com/energy</a>
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